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SHEET

To the Director of the U.S.

Please record the attached documents or the new address(es) below.

1. Name of conveying party(ies):

Masakatsu MAEDA
Yasuyuki YAMAMOTO
Yukihiro KANECHIKA

2. Name and address of receiving party(ies)

Name: Tokuyama Corporation

Internal Address:

1-1, Mikage-cho, Shunan-shi,
Yamaguchi

Street Address:

City:

State:

Zip:

Country: JAPAN

7458648

Additional name(s) of conveying party(ies) attached? ☐ Yes ☒ No

Additional name(s) & address(es) attached? ☐ Yes ☒ No

3. Nature of conveyance/Execution Date(s):

Execution Date(s) December 22, 2006

- ☒ Assignment ☐ Merger
☐ Security Agreement ☐ Change of Name
☐ Joint Research Agreement
☐ Government Interest Assignment
☐ Executive Order 9424, Confirmatory License
☐ Other

4. Application or patent number(s):

☒ This document is being filed together with a new application.

A. Patent Application No.(s)

B. Patent No.(s)

11/659158

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40.00 DP

Additional numbers attached? ☐ Yes ☒ No

5. Name and address to whom correspondence concerning document should be mailed:

Name: Kent E. Baldauf

Internal Address: The Webb Law Firm

Street Address: 700 Koppers Building
436 Seventh Avenue

City: Pittsburgh

State: PA Zip: 15219

Phone Number: 412-471-8815

Fax Number: 412-471-4094

Email Address: webblaw@webblaw.com

6. Total number of applications and patents involved: 1

7. Total fee (37 CFR 1.21(h) & 3.41) \$ 40.00

- ☐ Authorized to be charged by credit card
☐ Authorized to be charged to deposit account
☒ Enclosed (w/ filing fee)
☐ None required (government interest not affecting title)

8. Payment Information

- a. Credit Card Last 4 Numbers _____
Expiration Date _____
b. Deposit Account Number 23-0650
Authorized User Name _____

9. Signature:

Kent E. Baldauf
Signature

February 1, 2007

Date

Kent E. Baldauf, Reg. No. 25,826
Name of Person Signing

Total number of pages including cover sheet, attachments, and documents:

3

Documents to be recorded (including cover sheet) should be faxed to (571) 273-0140, or mailed to:
Mail Stop Assignment Recordation Services, Director of the USPTO, P.O. Box 1450, Alexandria, V.A. 22313-1450

Assignment of Application

INSERT NAMES
AND RESIDENCE
ADDRESS OF
THE INVENTORS:

WHEREAS, I (WE) 1) Masakatsu MAEDA, 2) Yasuyuki YAMAMOTO and 3) Yukihiro KANECHIKA of c/o TOKUYAMA CORPORATION, 1-1, Mikage-cho, Shunan-shi, Yamaguchi 7458648 Japan, respectively,

INSERT TITLE OF
INVENTION:

have invented certain new and useful improvements in: "LIGHT-EMITTING ELEMENT STORING PACKAGES AND A METHOD OF MANUFACTURING THE SAME"

(Application No. _____, filed _____), and

INSERT NAMES
AND ADDRESS OF
COMPANY OR
OTHER ASSIGNEE

WHEREAS, TOKUYAMA CORPORATION

(hereinafter referred to as "ASSIGNEE") having a place of business at : 1-1, Mikage-cho, Shunan-shi, Yamaguchi 7458648 Japan is desirous of acquiring the entire right, title and interest in and to said invention and in and to any Letters Patent that may be granted therefore in the United States and its territorial possessions and in any and all foreign countries;

NOW, THEREFORE, in consideration of the sum of FIVE DOLLARS (\$5.00), the receipt whereof is hereby acknowledged, and for other good and valuable consideration, I(WE), by these presents do sell, assign and transfer unto said ASSIGNEE, the full and exclusive right to the said invention in the United States and its territorial possessions and in all foreign countries and the entire right, title and interest in and to any and all Letters Patent which may be granted therefor in the United States and its territorial possessions and in any and all foreign countries and in and to any and all divisions, reissues, continuations, substitutions and renewals thereof.

I (WE) hereby authorize and request the Patent Office Officials in the United States and its territorial possessions and any and all foreign countries to issue any and all of said Letters Patent, when granted, to said ASSIGNEE as the assignee of my (our) entire right, title and interest in and to the same, for the sole use and behoof of said ASSIGNEE, its (his) successors and assigns, to the full end of the term for which said Letters Patent may be granted, as fully and entirely as the same would have been held by me (us) had this Assignment and sale not been made.

Further, I (WE) agree that I (WE) will communicate to said ASSIGNEE or its (his) representatives any facts known to me (us) respecting said invention, and testify in any legal proceeding, sign all lawful papers, execute all divisional, continuation, substitute, renewal and reissue applications, execute all necessary assignment papers to cause any and all of said Letter Patent to be issued to said ASSIGNEE, make all rightful oaths, and, generally do everything possible to aid said ASSIGNEE, its (his) successors and assigns, to obtain and enforce proper protection for said invention in the United States and its territorial possessions and in any and all foreign countries.

The undersigned hereby grant(s) the firm of THE WEBB LAW FIRM of 700 Koppers Building
436 Seventh Avenue
Pittsburgh PA 15219-1818
United States the power to insert on this assignment any further identification, including the application number and filing date, which may be necessary or desirable in order to comply with the rules of the United States Patent and Trademark Office for recordation of this document.

Date: <u>December 22, 2006</u>	<u>Masakatsu Maeda</u> (Signature of Inventor) Masakatsu MAEDA
Date: <u>December 22, 2006</u>	<u>Yasuyuki Yamamoto</u> (Signature of Inventor) Yasuyuki YAMAMOTO
Date: <u>December 22, 2006</u>	<u>Yukihiro Kanechika</u> (Signature of Inventor) Yukihiro KANECHIKA
Date: _____	_____ (Signature of Inventor)
Date: _____	_____ (Signature of Inventor)
Date: _____	_____ (Signature of Inventor)
Date: _____	_____ (Signature of Inventor)
Date: _____	_____ (Signature of Inventor)
Date: _____	_____ (Signature of Inventor)